X20(c)AO4622

1 General information

The module is equipped with four outputs with 13-bit (including sign) digital converter resolution. It is possible to select between the current and voltage signal using different connection terminal points.

- · 4 analog outputs
- · Either current or voltage signal possible
- · 13-bit digital converter resolution

2 Coated modules

Coated modules are X20 modules with a protective coating for the electronics component. This coating protects X20c modules from condensation and corrosive gases.

The modules' electronics are fully compatible with the corresponding X20 modules.

For simplification purposes, only images and module IDs of uncoated modules are used in this data sheet.

The coating has been certified according to the following standards:

- · Condensation: BMW GS 95011-4, 2x 1 cycle
- Corrosive gas: EN 60068-2-60, Method 4, Exposure 21 days







3 Order data

Table 1: X20AO4622, X20cAO4622 - Order data

4 Technical data

Product ID	X20AO4622	X20cAO4622			
Short description	AZUAUTUZZ	AZUCAOTUZZ			
I/O module	4 analog outputs ±10 V or 0 to 20 mA / 4 to 20 mA ¹⁾	4 analog outputs ±10 V or 0 to 20 mA / 4 to 20 mA			
General information	Tanalog outpute 2 To V of a to 20 Hill V T to 20 Hill V	Tunding dupute 110 v of 0 to 20 mil (1 to 20 mil)			
B&R ID code	0x1BA3	0xE212			
Status indicators		perating state, module status			
Diagnostics	ii o namenem per emarimen, ep	oracing state, medale status			
Module run/error	Yes, using status	LED and software			
Channel type	-	g software			
Power consumption		·			
Bus	0.0	1 W			
Internal I/O	1.8 W (Rev. ≥ J0); 2.2 W (Rev. < J0)	1.8 W			
Additional power dissipation caused by the actuators (resistive) [W]		-			
Electrical isolation					
Channel - Bus	1	es			
Channel - Channel	N	lo			
Certification					
CE		es			
cULus		es '			
cCSAus HazLoc Class 1 Division 2	Yes	-			
ATEX Zone 2 2)		es I			
KC GL	Yes	es			
GOST-R		es es			
Analog outputs	Ye	ေ			
Output	±10 V or 0 to 20 mA / 4 to 20 mA.	±10 V or 0 to 20 mA / 4 to 20 mA,			
Output	via different terminal connections 1)	via different terminal connections			
Max. output current		oltages >5 V			
	15 mA at vo	oltages <5 V			
Digital converter resolution					
Voltage		2-bit			
Current		Bit			
Conversion time	300 μs for all outputs				
Settling time for output changes over entire range	500 μs				
Power on/off behavior	internal enable	relay for booting			
Max. error at 25°C					
Voltage Gain	0.09	30/- 3)			
Offset	0.08% ³⁾ 0.05% ⁴⁾				
Current	0.03 /0 1				
Gain	0.09	3 % ³⁾			
Offset	1	5% ⁴⁾			
Output protection	Short circui	it protection			
Output format					
Voltage	INT 0x8001 - 0x7FFF / 1 I	LSB = 0x0010 = 4.882 mV			
Current	l e e e e e e e e e e e e e e e e e e e	LSB = 0x0010 = 9.766 μA			
Load per channel					
Voltage	Max. ±10 mA	A, load ≥1 kΩ			
Current	Load max. 600 Ω (Rev. ≥ J0); 500 Ω (Rev. < J0)	Max. load is 600 Ω			
Short circuit protection		ting ±40 mA			
Output filter	1st-order low pass / ci	utoff frequency 10 kHz			
Max. gain drift					
Voltage		%/°C ³⁾			
Current	0.02 9	%/°C ³)			
Max. offset drift		0//00/0			
Voltage	1	%°C 4)			
Current	0.032	%/°C ⁴)			
Error caused by load change	May 0 440/ 5 40	MO . 1 kO registive			
Voltage	· ·	$M\Omega \rightarrow 1 \text{ k}\Omega$, resistive			
Current Nonlinearity		$\Omega \to 600 \ \Omega$, resistive			
INCHILLEALITY	<0.005% 5)				
		1 V			
Isolation voltage between channel and bus	500) V _{eff}			
Isolation voltage between channel and bus Operating conditions		V _{eff}			
Isolation voltage between channel and bus Operating conditions Mounting orientation	500				
Isolation voltage between channel and bus Operating conditions Mounting orientation Horizontal	5000 Y4	es			
Isolation voltage between channel and bus Operating conditions Mounting orientation Horizontal Vertical	5000 Y4				
Isolation voltage between channel and bus Operating conditions Mounting orientation Horizontal Vertical Installation at elevations above sea level	70 Ye	es es			
Isolation voltage between channel and bus Operating conditions Mounting orientation Horizontal Vertical Installation at elevations above sea level 0 to 2000 m	Yo Yo No limi	es es itations			
Isolation voltage between channel and bus Operating conditions Mounting orientation Horizontal Vertical Installation at elevations above sea level	Yo Yo No limi Reduction of ambient temp	es es			

Table 2: X20AO4622, X20cAO4622 - Technical data

Product ID	X20AO4622	X20cAO4622			
Environmental conditions					
Temperature					
Operation					
Horizontal installation	-25 to 60°C (Rev. ≥ J0); 0 to 55°C (Rev. < J0)	-25 to 60°C			
Vertical installation	-25 to 50°C (Rev. ≥ J0); 0 to 50°C (Rev. < J0)	-25 to 50°C			
Derating	See section	n "Derating"			
Storage	-40 to 85°C				
Transport	-40 to 85°C				
Relative humidity					
Operation	5 to 95%, non-condensing	Up to 100%, condensing			
Storage	5 to 95%, no	n-condensing			
Transport	5 to 95%, non-condensing				
Mechanical characteristics					
Note	Order 1x X20TB12 terminal block separately	Order 1x X20TB12 terminal block separately			
	Order 1x X20BM11 bus module separately	Order 1x X20cBM11 bus module separately			
Spacing	12.5 +	^{0.2} mm			

Table 2: X20AO4622, X20cAO4622 - Technical data

- 1) 4 to 20 mA: From upgrade version 1.0.2.0 or hardware revision "I0"
- 2) Ta min.: 0°C
- Ta max.: See environmental conditions
- 3) Based on the current output value.
- 4) Based on the entire output range.
- 5) Based on the output range.

5 LED status indicators

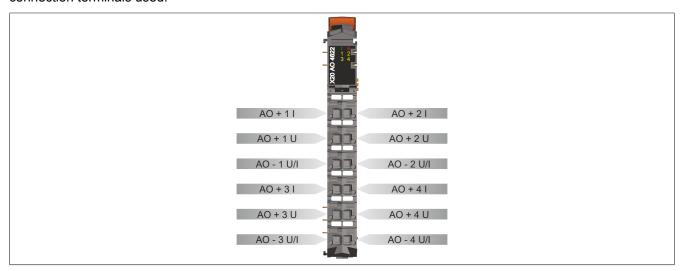
For a description of the various operating modes, see the section "re LEDs" in chapter 2 "System characteristics" of the X20 system user's manual.

Figure	LED	Color	Status	Description
r		Green Off		No power to module
			Single flash	RESET mode
			Double flash	BOOT mode (during firmware update) ¹⁾
CI C			Blinking PREOPERATIONAL mode	
1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2			On	RUN mode
0 3 4	е	Red	Off No power to module or everything OK	
4			On	Error or reset status
X20	e + r	Red on / Green	single flash	Invalid firmware
×	1 - 4	Orange	Off	Value = 0
The second second			On	Value ≠ 0

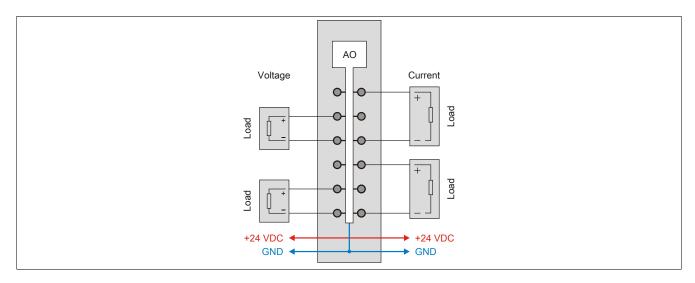
¹⁾ Depending on the configuration, a firmware update can take up to several minutes.

6 Pinout

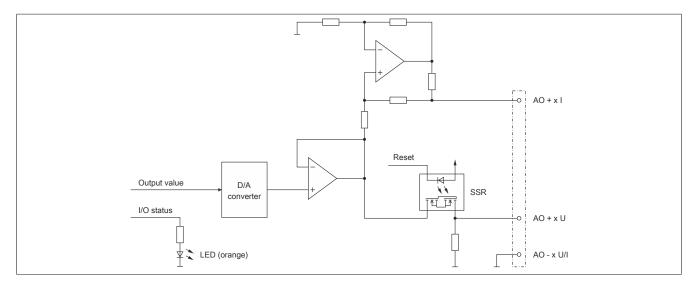
Each channel can be configured for either current or voltage signals. The type of signal is also determined by the connection terminals used.



7 Connection example



8 Output circuit diagram

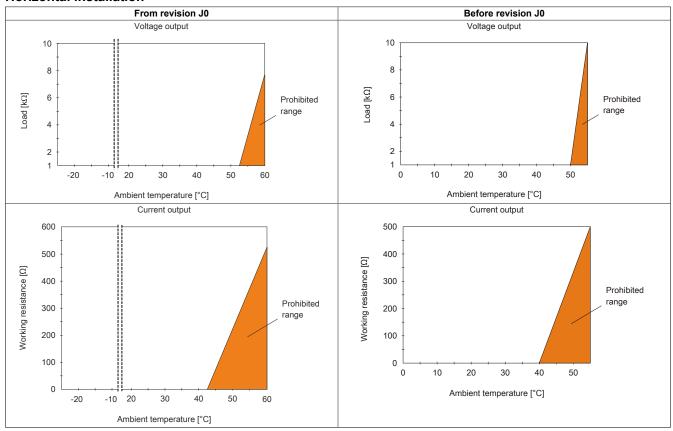


9 Derating

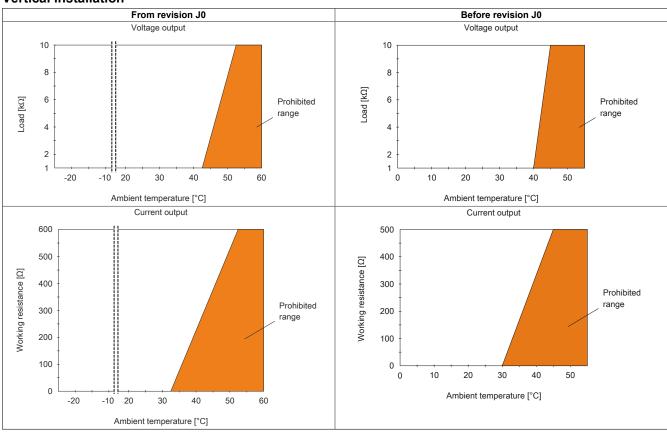
To ensure proper operation, the following items must be taken into consideration:

- The following derating listings must be taken into consideration
- · For mixed operation with one current output, the average of both derating curves should be used
- · For mixed operation with two or three current outputs, the derating for the current outputs should be used

Horizontal installation



Vertical installation



10 Register description

10.1 General data points

In addition to the registers listed in the register description, the module also has other more general data points. These registers are not specific to the module but contain general information such as serial number and hardware version.

These general data points are listed in the "General data points" section of chapter 4 "X20 system modules" in the X20 system user's manual.

10.2 Function model 0 - Standard and function model 1 - I/O with fast reaction

Register	Name	Data type	Read		Write	
			Cyclic	Non-cyclic	Cyclic	Non-cyclic
Analog signal	- Configuration					
18	ConfigOutput01	USINT				•
Analog signal	- Communication					
0	AnalogOutput01	INT			•	
2	AnalogOutput02	INT			•	
4	AnalogOutput03	INT			•	
6	AnalogOutput04	INT			•	

10.3 Function model 254 - Bus controller

Register	Offset1)	Name	Data type	Read		Write	
				Cyclic	Non-cyclic	Cyclic	Non-cyclic
Analog signal	- Configuration	1					
18	-	ConfigOutput01	USINT				•
Analog signal	- Communicati	on					
0	0	AnalogOutput01	INT			•	
2	2	AnalogOutput02	INT			•	
4	4	AnalogOutput03	INT			•	
6	6	AnalogOutput04	INT			•	

The offset specifies the position of the register within the CAN object.

10.3.1 CAN I/O bus controller

The module occupies 1 analog logical slot on CAN-I/O.

10.4 Function model comparison

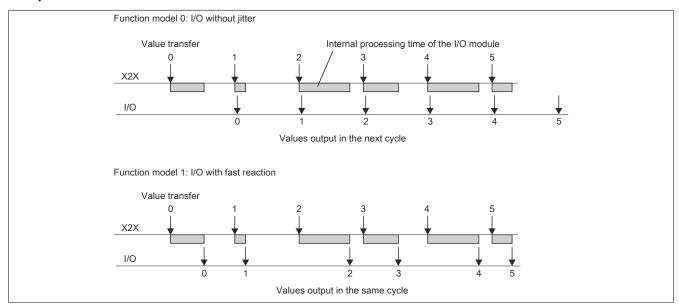
Function model 0: I/O without jitter (standard)

Corrected values are output in the next cycle if the minimum cycle is ≥400 µs in order to reduce jitter to a minimum.

Function model 1: I/O with fast reaction

Corrected values are output in the same cycle if the minimum cycle is ≥400 µs (optimized reactions).

Comparison of the two function models



10.5 Analog outputs

Each channel can be configured for either current or voltage signals. The type of signal is also determined by the connection terminals used.

10.5.1 Output values of the analog output

Name:

AnalogOutput01 to AnalogOutput04

These registers provide the standardized output values. Once a permitted value is received the module outputs the respective current or voltage.

Data type	Value	Information
INT	-32768 to 32767	Voltage signal -10 to 10 VDC
	0 to 32767	Current signal 0 to 20 mA
	0 to 32767	Current signal 4 to 20 mA ¹⁾

1) From upgrade version 1.0.2.0 or hardware revision "I0"

10.5.2 Setting the channel type

Name:

ConfigOutput01

This register can be used to set the channel type of the outputs.

Each channel is capable of handling either current or voltage signals. The type of signal is determined by the connection terminals used. Since current and voltage require different adjustment values, it is also necessary to configure the desired type of output signal. The following output signals can be set:

- ±10 V voltage signal (default)
- · 0 to 20 mA current signal
- · 4 to 20 mA current signal

Data type	Value
USINT	See bit structure.

Bit structure:

Bit	Description	Value	Information
0	Channel 1	0	Voltage signal
		1	Current signal, measurement range corresponding to bit 4
3	Channel 4	0	Voltage signal
		1	Current signal, measurement range corresponding to bit 7
4	Channel 1: Current measurement range	0	0 to 20 mA current signal
		1	4 to 20 mA current signal
7	Channel 4: Current measurement range	0	0 to 20 mA current signal
		1	4 to 20 mA current signal

10.6 Minimum cycle time

The minimum cycle time defines how far the bus cycle can be reduced without communication errors occurring. It should be noted that very fast cycles decrease the idle time available for handling monitoring, diagnostics and acyclic commands.

Minimum cycle time	
250 μs	

10.7 Minimum I/O update time

The minimum I/O update time defines how far the bus cycle can be reduced while still allowing an I/O update to take place in each cycle.

Minimum I/O update time
400 μs